

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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## UTILITY PATENT APPLICATION TRANSMITTAL Under 37 C.F.R. 1.53(b)

Attorney Docket No: PD- 202005

First Named Inventor: Udaya Bhaskar et al.

Title: Prototype Waveform Phase Modeling for  
a Frequency Domain Interpolative  
Speech Codec System

Customer No: 20991

Assistant Commissioner for Patents  
Washington, D.C. 20231

Transmitted herewith for filing is the patent application including:

### APPLICATION PARTS:

- ☒ Specification [Total Pages 88]  
☒ Drawings [Total Sheets 10]  
☒ Oath or Declaration [Total Pages 1 (blank)]  
a. ☐ Newly executed (original or copy)  
b. ☐ Copy from prior application (37 CFR 1.63d)  
(for continuation or divisional application)  
i. ☐ **DELETION OF INVENTORS**  
Signed Statement attached deleting  
inventor(s) named in the prior application,  
see 37 CFR 1.63(d)(2) and 1.33(b).

### ACCOMPANYING APPLICATION PARTS:

4. ☐ Assignment (cover sheet and documents)  
5. ☐ Power of Attorney (included in Oath or Declaration)  
6. ☐ Information Disclosure Statement (IDS/PTO1449)  
a. ☐ Copies of IDS Citations  
7. ☐ Preliminary Amendment  
8. ☒ Return Receipt Postcard (MPEP 503)  
9. ☐ Certified Copy of Priority Documents  
(If foreign priority is claimed)  
10. ☒ Other *Request and Certification*  
*under 35 USC 812(b)(2)(B)(i)*

### 11. CONTINUING APPLICATION:

☐ Continuation ☐ Divisional ☐ Continuation-in-part (CIP) of prior application No.

Prior application information: Examiner:

Group/Art Unit:

For CONTINUATION or DIVISIONAL applications only: The entire disclosure of the prior application, from which an oath or declaration is supplied under Box 3b, is considered a part of the disclosure of the accompanying continuation or divisional application and is hereby incorporated by reference. The incorporation can only be relied upon when a portion has been inadvertently omitted from the submitted application parts.

- a. ☐ Amend the Specification by inserting before the first line the following sentence:  
-- --  
b. ☐ The prior application is assigned to HUGHES ELECTRONICS CORPORATION.  
c. ☐ The power of attorney of the prior application is to  
d. ☐ Please cancel claims in the prior application before calculating the filing fee below.  
e. ☐ I hereby certify that the attached papers are a true copy of the prior application Serial No. as originally filed on

**12. FEE TRANSMITTAL:**

	<u>No. Filed</u>		<u>Extra</u>	<u>Rate</u>	<u>Fee</u>
Basic Fee				\$ 740.00	\$ 740.00
Total Claims	22	- 20 =	2 x	\$ 18.00 =	\$ 36.00
Independent Claims	2	- 3 =	0 x	\$ 84.00 =	\$
Multiple Dependent Claims			(Y/N)	\$ 270.00	\$
<b>TOTAL FILING FEE</b>					<b>\$ 776.00</b>

Please charge deposit account No. 50-0383 of Hughes Electronics Corporation, El. Segundo, California, in the amount of the Total Filing Fee calculated above. The Commissioner is hereby authorized to charge any additional fees that may be due, or credit any overpayment, to that deposit account.

13. The Commissioner is hereby further authorized to charge Deposit Account No. 50-0383, pursuant to 37 CFR 1.25(b), any fees that may properly become due or payable, as set forth in 37 CFR 1.16 and 1.17, for the entire pendency of this application without any additional authorization.

14. This form is being submitted in triplicate.

**15. CORRESPONDENCE ADDRESS:**

Name: Hughes Electronics Corporation  
Patent Docket Administration  
Address: P.O. Box 956  
Bldg. 1, Mail Stop A109  
City/State/Zip: El Segundo, CA 90245-0956

Signature:   
Name (Print/Type): Craig L. Plastrik, Reg. No. 41,254

Date: 2/13/2002

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Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number

<b>REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)</b>	First Named Inventor		Udaya Bhaskar et al.
	Title	Prototype Waveform Phase Modeling for a Frequency Domain Interpolative Speech CODEC System	
	Atty Docket Number		PD-202005

I hereby certify that the invention disclosed in the attached application **has not and will not be** the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

February 13, 2002

Date



Signature

Peter Kendall

Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**

**Burden Hour Statement** This collection of information is required by 37 CFR 1.213(a). The information is used by the public to request that an application not be published under 35 U.S.C. 122(b) (and the PTO to process that request). Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This form is estimated to take 6 minutes to complete. This time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.